GBU4005 THRU GBU410

GLASS PASSIVATED SINGLE-PHASE BRIDGE RECTIFIER



REVERSE VOLTAGE: 50 to 1000 VOLTS FORWARD CURRENT: 4.0 AMPERE

FEATURES

· Glass passivated chip junction

 Reliable low cost construction utilizing molded plastic technique

· Ideal for printed circuit board

· Low forward voltage drop

· Low reverse leakage current

· High surge current capability

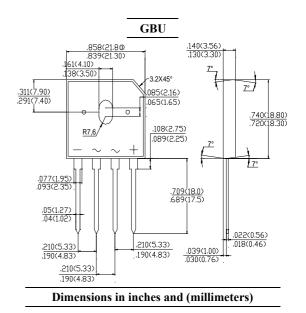
MECHANICAL DATA

Case: Molded plastic, GBU

Epoxy: UL 94V-O rate flame retardant

Terminals: Leads solderable per MIL-STD-202,

method 208 guaranteed Mounting position: Any Weight: 0.15ounce, 4.0gram



Maximum Ratings and Electrical Characteristics

Ratings at 25 ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	GBU4005	GBU401	GBU402	GBU404	GBU406	GBU408	GBU410	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward T _C =100 (Note 1)		4.0 3.0							Amp
Rectified Current at $T_A = 40$ (Note 2)	I _(AV)								
Peak Forward Surge Current,									
8.3ms single half-sine-wave	I_{FSM}	I _{FSM} 150							Amp
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage	V	1.0							Volts
at 4.0A DC and 25	$\mathbf{V_F}$								
Maximum Reverse Current at T _A =25	т	5.0 500							uAmp
at Rated DC Blocking Voltage T _A =125	I_R								
Typical Junction Capacitance (Note 3)	C_{J}		10	00			45		pF
Typical Thermal Resistance (Note 2)	$R_{\theta JA}$	22						/W	
Typical Thermal Resistance (Note 1)	$R_{\theta JC}$	4.2						/W	
Operating and Storage Temperature Range	T _J , Tstg	-55 to +150							

NOTES: 1- Unit case mounted on 1.6 x 1.6 x 0.06" thick (4.0 x 4.0 x 0.15cm) Al. Plate

- 2- Units mounted on P.C.B. with 0.5 x 0.5" (12 x 12mm) copper pads and 0.375" (9.5mm) lead length
- 3- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.
- 4- Recommended mounting position is to bolt down on heatsink with silicone thermal compound for maximum heat transfer with #6 screw



RATINGS AND CHARACTERISTIC CURVES

Fig. 1 — Derating Curve **Output Rectified Current** Heatsink Mounting, To Average Forward Output Current (A) 1.6 x 1.6 x 0.06" Thk (4.0 x 4.0 x .15cm) AL. Plate 3.0 2.0 1.0 P.C.B. Mounting, T_A
0.47 x 0.47" (12 x 12mm) Copper Pads 0.375" (9.5mm) Lead Length 60 Hz Resistive or Inductive Load 100 0 150 Temperature (°C)

Fig. 2 — Maximum Non-Repetitive
Peak Forward Surge Current Per Leg

150

T_J = T_J max.
Single Sine-Wave
(JEDEC Method)

100

Number of Cycles at 60 Hz

